IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.: 09/677,558

Title: SEMICONDUCTOR POWER
MODULE HAVING AN ELECTRICALLY
INSULATING HEAT SINK AND
METHOD OF MANUFACTURING THE
SAME

Filed: September 29, 2000

ants: JEUN et al.

Group Art Unit: 2814

Examiner: DiLinh Nguyen

Atty. Docket Number: 29347/990488

Customer No.: 04743

I hereby certify that this paper is being deposited with the United States Postal Service, first class postage prepaid, addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450, on the date indicated: July 7, 2005.

Aaron M. Peters Reg. No. 48,801

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AMENDMENT "F"

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

In response to the official action dated April 7, 2005, the applicants respectfully request that the application be reconsidered in light of the following amendments and remarks.

Amendments to the claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.